



BOOTH APPLICATION FORM

Application Deadline: MAY 10, 2024

Applications will be accepted on first come first served basis subject to availability.

APPLICATION PROCESS

- 1. Please fill out the application form below or on the official website.
- 2. E-mail the copy to: tokyopack@jpi.or.jp by May 10, 2024.
- 3. The invoice will be sent from TOKYOPACK 2024 Secretariat within 10 days after receiving the application form.

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Company/Organization Name:						
Address:						
Country:						
Tel :	Website:					
Contact person: Mr./Ms	Title:					
Contact E-mail:						
Agent or representative in Japan, if you have	e one :					
Address:						
Contact Person:	Position:					
Tel : Fax:	E-mail:					
BOOTHS: We wish to purchase booth(s	s). (1 booth =2.97m X2.97m)					
	Booth(s) = ¥ (JPY)					
¥ 374,000 before Dec.15,	2023 (Early Bird) *10%Consumption Tax included					
Please circle the preferred space layout if you purchase 4 booths or more.						
 Single line Block Type 4 	2. Double line3. Block Type 35. Block Type 5					
Early Bird Special: A discount of 11,000 yen	per booth when you submit your applications before Dec. 15, 2023.					
	oth will be deducted for the purchase of more than 20 booths. oth will be deducted for the purchase of more than 30 booths.					
EXHIBITS: Product category (Please check all applicable exhibiting products): 1□. Packaging Materials / Containers 2□. Packaging Machines 3□. Printing / Converting Machines						

^{*}Application is considered as accepted once the participation fee is paid.

Signature:	Date:
I / We, the undersigned, hereby apply for e the terms and regulations described in the	exhibition space in TOKYO PACK 2024 as indicated above under Application Outline and Terms of Exhibition.
Please fill in the details of the products to be	be displayed in TOKYOPACK2024
5□. Inspection / Measurement / € 6□. Packaging Design / Commun 7□. Packaging & Logistics Soluti 8 . Next Generation Technologic 9□. PR • PRESS	nication / Service ions

For more information and contact:

TOKYO PACK 2024 Secretariat c/o Japan Packaging Institute

Email: tokyopack@jpi.or.jp

Tel: +81-3-3543-1189